IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Application of: Gunther et al. Serial No.: 09/784,255

Filed: February 14, 2001

For: Methods and Apparatus for Thermal Management of an Integrated Circuit

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Examiner: Unknown

Group Art Unit: 2859

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rson Mailing Correspondence

Commissioner for Patents Washington, D.C. 20231

PRELIMINARY AMENDMENT

Sir:

This paper is being filed as a preliminary amendment for the above-referenced matter. The Applicants request that the following amendments be entered prior to examination on the merits.